MAAP-011233

Power Amplifier, 4 W
28.5 - 31 GHz

Features
- High Gain: 25 dB @ 30 GHz
- P1dB: 34.5 dBm
- P3dB: 36 dBm
- IM3 Level: -27 dBc @ P_{OUT} 29 dBm/tone
- Power Added Efficiency: 27.5 % at P3dB
- Lead-Free 5 mm 32-lead AQFN Package
- RoHS* Compliant

Description
The MAAP-011233 is a 4-stage, 4 W power amplifier assembled in a lead-free 5 mm 32-lead AQFN plastic package. This power amplifier operates from 28.5 to 31 GHz and provides 26 dB of linear gain, 4 W saturated output power and 27.5 % efficiency while biased at 6 V.

The MAAP-011233 can be used as a power amplifier ideally suited for VSAT communications.

This product is fabricated using a GaAs pHEMT process which features full passivation for enhanced reliability.

Ordering Information

<table>
<thead>
<tr>
<th>Part Number</th>
<th>Package</th>
</tr>
</thead>
<tbody>
<tr>
<td>MAAP-011233</td>
<td>Bulk</td>
</tr>
<tr>
<td>MAAP-011233-TR0500</td>
<td>500 Piece Reel</td>
</tr>
<tr>
<td>MAAP-011233-SMB</td>
<td>Sample Board</td>
</tr>
</tbody>
</table>

1. Reference Application Note M513 for reel size information.
2. All sample boards include 3 loose parts.

Functional Schematic

Pin Configuration

<table>
<thead>
<tr>
<th>Pin No.</th>
<th>Pin Name</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>4</td>
<td>RF\text{IN}</td>
<td>RF Input</td>
</tr>
<tr>
<td>10, 11</td>
<td>V\text{G}</td>
<td>Gate Voltage</td>
</tr>
<tr>
<td>14, 27, 28</td>
<td>V_{D3}</td>
<td>Drain Voltage 3</td>
</tr>
<tr>
<td>15, 26</td>
<td>V_{D4}</td>
<td>Drain Voltage 4</td>
</tr>
<tr>
<td>21</td>
<td>RF\text{OUT}</td>
<td>RF Output</td>
</tr>
<tr>
<td>29</td>
<td>V_{D2}</td>
<td>Drain Voltage 2</td>
</tr>
<tr>
<td>31</td>
<td>V_{D1}</td>
<td>Drain Voltage 1</td>
</tr>
<tr>
<td>1, 3, 5, 8, 9, 16, 17, 20, 22, 24, 25, 32</td>
<td>GND</td>
<td>Ground</td>
</tr>
<tr>
<td>2, 6, 7, 12, 13, 18, 19, 23, 30</td>
<td>N/C</td>
<td>No Connection</td>
</tr>
</tbody>
</table>

3. MACOM recommends connecting all No Connection (N/C) pins to ground.
4. The exposed pad centered on the package bottom must be connected to RF, DC and thermal ground.


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**Power Amplifier, 4 W**

**28.5 - 31 GHz**

**Electrical Specifications:** Freq. = 30 GHz, $T_A = +25^\circ$C, $V_D = 6$ V, $Z_0 = 50$ Ω

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Test Conditions</th>
<th>Units</th>
<th>Min.</th>
<th>Typ.</th>
<th>Max.</th>
</tr>
</thead>
<tbody>
<tr>
<td>Gain</td>
<td>$P_{IN} = 0$ dBm</td>
<td>dB</td>
<td>22</td>
<td>25.0</td>
<td>—</td>
</tr>
<tr>
<td>$P_{OUT}$</td>
<td>$P_{IN} = +14$ dBm</td>
<td>dBm</td>
<td>34.5</td>
<td>36.0</td>
<td>—</td>
</tr>
<tr>
<td>IM3 Level</td>
<td>$P_{OUT} = 29$ dBm / tone</td>
<td>dBC</td>
<td>—</td>
<td>-27.0</td>
<td>—</td>
</tr>
<tr>
<td>Power Added Efficiency</td>
<td>$P_{IN} = +14$ dBm</td>
<td>%</td>
<td>—</td>
<td>27.5</td>
<td>—</td>
</tr>
<tr>
<td>Input Return Loss</td>
<td>$P_{IN} = -20$ dBm</td>
<td>dB</td>
<td>—</td>
<td>10</td>
<td>—</td>
</tr>
<tr>
<td>Output Return Loss</td>
<td>$P_{IN} = -20$ dBm</td>
<td>dB</td>
<td>—</td>
<td>10</td>
<td>—</td>
</tr>
<tr>
<td>Quiescent Current</td>
<td>$I_DQ$ (see bias conditions, page 4 )</td>
<td>mA</td>
<td>—</td>
<td>2000</td>
<td>—</td>
</tr>
<tr>
<td>Current</td>
<td>$P_{IN} = +14$ dBm</td>
<td>mA</td>
<td>—</td>
<td>2800</td>
<td>3600</td>
</tr>
</tbody>
</table>

**Maximum Operating Ratings**

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Rating</th>
</tr>
</thead>
<tbody>
<tr>
<td>Input Power</td>
<td>14 dBm</td>
</tr>
<tr>
<td>Junction Temperature$^5,6$</td>
<td>+160°C</td>
</tr>
<tr>
<td>Operating Temperature</td>
<td>-40°C to +85°C</td>
</tr>
</tbody>
</table>

5. Operating at nominal conditions with junction temperature \(T_J\) \(< +160°C\) will ensure MTTF > 1 \(\times 10^6\) hours.

6. Junction Temperature \(T_J = T_C + \Theta_{JC} \times (V \times I - (P_{OUT} - P_{IN}))\). Typical thermal resistance \(\Theta_{JC}\) = 4.4 °C/W.

5a) For \(T_C = +25°C\),

\[T_J = +82°C \at 6 V, 2.8 A, P_{OUT} = 36 dBm, P_{IN} = 14 dBm\]

5b) For \(T_C = +85°C\),

\[T_J = +137°C \at 6 V, 2.5 A, P_{OUT} = 35 dBm, P_{IN} = 14 dBm\]

**Absolute Maximum Ratings**$^7,8$

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Absolute Maximum</th>
</tr>
</thead>
<tbody>
<tr>
<td>Input Power</td>
<td>20 dBm</td>
</tr>
<tr>
<td>Drain Voltage</td>
<td>6.5 V</td>
</tr>
<tr>
<td>Gate Voltage</td>
<td>-3 to 0 V</td>
</tr>
<tr>
<td>Junction Temperature$^8$</td>
<td>+175°C</td>
</tr>
<tr>
<td>Storage Temperature</td>
<td>-65°C to +125°C</td>
</tr>
</tbody>
</table>

7. Exceeding any one or combination of these limits may cause permanent damage to this device.

8. MACOM does not recommend sustained operation near these survivability limits.

9. Junction temperature directly effects device MTTF. Junction temperature should be kept as low as possible to maximize lifetime.

**Handling Procedures**

Please observe the following precautions to avoid damage:

**Static Sensitivity**

These electronics devices are sensitive to electrostatic discharge (ESD) and can be damaged by static electricity. Proper ESD control techniques should be used when handling these HBM Class 1A devices.
Sample Board Layout

Application Schematic

Parts List

<table>
<thead>
<tr>
<th>Part</th>
<th>Value</th>
<th>Case Style</th>
</tr>
</thead>
<tbody>
<tr>
<td>C1 - C7</td>
<td>0.01 µF</td>
<td>0402</td>
</tr>
<tr>
<td>C8 - C12</td>
<td>1 µF</td>
<td>0603</td>
</tr>
<tr>
<td>C13 - C16</td>
<td>10 µF</td>
<td>0805</td>
</tr>
<tr>
<td>R1 - R7</td>
<td>10 Ω</td>
<td>0402</td>
</tr>
<tr>
<td>L1 - L4 (Chip Ferrite Bead)</td>
<td>BLM18HE601SN1D</td>
<td>0603</td>
</tr>
</tbody>
</table>

Sample Board Material Specifications

- **Top Layer**: 1/2 oz Copper Cladding, 0.017 mm thickness
- **Dielectric Layer**: Rogers RO4003C, 0.203 mm thickness
- **Bottom Layer**: 1/2 oz Copper Cladding, 0.017 mm thickness
- **Finished overall thickness**: 0.238 mm

For further information and support please visit: [https://www.macom.com/support](https://www.macom.com/support)
Sample Board Layout:
RF input and output port pre-matching circuit patterns are designed to compensate for packaging effects. Input and output patterns are identical.

Copper-filled vias are required beneath the package. Diameter = 0.3 mm, Space = 0.5 mm, 7x7 array. All units are in μm.

Biasing Conditions
Recommended biasing conditions are \( V_D = 6 \text{ V} \), \( I_{DO} = 2 \text{ A} \) (controlled with \( V_G \)). The drain bias voltage range is 3 to 6 V, and the quiescent drain current biasing range is 1.5 to 2.5 A.

\( V_G \) pins 10 and 11 are connected internally; choose either pin for layout convenience. Muting can be accomplished by setting the \( V_G \) to the pinched off voltage (\( V_G = -2 \text{ V} \)).

\( V_D \) bias must be applied to \( V_{D1}, V_{D2}, V_{D3}, \) and \( V_{D4} \) pins.

\( V_{D3} \) pins 14 and either pin 27 or 28 are required for current symmetry. Pins 27 and 28 are connected internally; choose either pin for layout convenience.

Both \( V_{D4} \) pins 15 and 26 are required for current symmetry.

Operating the MAAP-011233

**Turn-on**
1. Apply \( V_G \) (-1.5 V).
2. Apply \( V_{D1}, V_{D2}, V_{D3}, V_{D4} \) (6.0 V typical).
3. Set \( I_{DO} \) by adjusting \( V_G \) more positive (typically -0.9 to -1.0 V for \( I_{DO} = 2 \text{ A} \)).
4. Apply RF\(_{IN} \) signal.

**Turn-off**
1. Remove RF\(_{IN} \) signal.
2. Decrease \( V_G \) to -1.5 V.
3. Decrease \( V_{D1}, V_{D2}, V_{D3}, V_{D4} \) to 0 V.

Application Information
The MAAP-011233 is designed to be easy to use yet high performance. The ultra small size and simple bias allow easy placement on system board. RF input and output ports are DC de-coupled internally.
Power Amplifier, 4 W
28.5 - 31 GHz

Typical Performance Curves

Small Signal Gain vs. Frequency over Temperature

Input Return Loss vs. Frequency over Temperature

Output Return Loss vs. Frequency over Temperature

Small Signal Gain vs. Frequency over Bias Voltage

Input Return Loss vs. Frequency over Bias Voltage

Output Return Loss vs. Frequency over Bias Voltage

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Typical Performance Curves

**P3dB vs. Frequency over Temperature**

- **P3dB vs. Frequency over Bias Voltage**

**P1dB vs. Frequency over Temperature**

- **P1dB vs. Frequency over Bias Voltage**
MAAP-011233

Power Amplifier, 4 W
28.5 - 31 GHz

Typical Performance Curves: P_{OUT} = 29 dBm / Tone

Output IP3 vs. Frequency over Temperature

Output IP3 vs. Frequency over Bias Voltage

IM3 vs. Frequency over Temperature

IM3 vs. Frequency over Bias Voltage

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DC-0014481
Typical Performance Curves

**P1dB & P3dB vs. Frequency**

![P1dB & P3dB vs. Frequency Graph](image)

**PAE & Gain @ P3dB vs. Frequency**

![PAE & Gain @ P3dB vs. Frequency Graph](image)

**IM3 vs. Output Power**

![IM3 vs. Output Power Graph](image)

**Output IP3 vs. Output Power**

![Output IP3 vs. Output Power Graph](image)
Power Amplifier, 4 W
28.5 - 31 GHz

Typical Performance Curves

Output Power vs. Input Power

PAE vs. Input Power

Bias Current vs. Input Power

Quiescent Drain Current vs. Temperature

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Lead-Free 5 mm 32-Lead AQFN Package†

Reference Application Note S2083 for lead-free solder reflow recommendations.
Meets JEDEC moisture sensitivity level 3 requirements.
Plating is NiPdAu.

All dimensions shown as inches [mm].
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